



501.37120X00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: TSUBOSAKI et al.
Serial No.: 09/308,620
Filed: July 20, 1999
For: SEMICONDUCTOR DEVICE AND
MANUFACTURING METHOD THEREOF
Group: 2811
Examiner: L. Thai

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AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

August 14, 2001

Sir:

In response to the Office Action dated March 14, 2001, the period of response for which extension is requested in the attached Petition for Extension of Time, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

IN THE CLAIMS:

Please cancel claim 12 without prejudice or disclaimer of the subject matter therein.

Please amend claims 1 and 5, as follows:

1. (Twice Amended) A semiconductor device including a semiconductor chip having a principal surface and a back surface, opposite to said principal surface,